

IGBT Power Module

- Single switch
- Including fast free-wheeling diodes
- Package with insulated metal base plate



Type	V_{CE}	I_C	Package	Ordering Code
BSM 300 GA 120 DN2	1200V	430A	SINGLE SWITCH 1	C67076-A2007-A70
BSM 300 GA 120 DN2 S	1200V	430A	SSW SENSE 1	C67070-A2017-A70

Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	V_{CE}	1200	V
Collector-gate voltage $R_{GE} = 20 \text{ k}\Omega$	V_{CGR}	1200	
Gate-emitter voltage	V_{GE}	± 20	
DC collector current $T_C = 25 \text{ }^\circ\text{C}$ $T_C = 80 \text{ }^\circ\text{C}$	I_C	430 300	A
Pulsed collector current, $t_p = 1 \text{ ms}$ $T_C = 25 \text{ }^\circ\text{C}$ $T_C = 80 \text{ }^\circ\text{C}$	I_{Cpuls}	860 600	
Power dissipation per IGBT $T_C = 25 \text{ }^\circ\text{C}$	P_{tot}	2500	W
Chip temperature	T_j	+ 150	$^\circ\text{C}$
Storage temperature	T_{stg}	-40 ... + 125	
Thermal resistance, chip case	R_{thJC}	≤ 0.05	K/W
Diode thermal resistance, chip case	R_{thJCD}	≤ 0.125	
Insulation test voltage, $t = 1 \text{ min.}$	V_{is}	2500	Vac
Creepage distance	-	20	mm
Clearance	-	11	
DIN humidity category, DIN 40 040	-	F	sec
IEC climatic category, DIN IEC 68-1	-	40 / 125 / 56	

Electrical Characteristics, at $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Gate threshold voltage $V_{GE} = V_{CE}, I_C = 12\text{ mA}$	$V_{GE(th)}$	4.5	5.5	6.5	V
Collector-emitter saturation voltage $V_{GE} = 15\text{ V}, I_C = 300\text{ A}, T_j = 25\text{ °C}$ $V_{GE} = 15\text{ V}, I_C = 300\text{ A}, T_j = 125\text{ °C}$	$V_{CE(sat)}$	- -	2.5 3.1	3 3.7	
Zero gate voltage collector current $V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}, T_j = 25\text{ °C}$ $V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}, T_j = 125\text{ °C}$	I_{CES}	- -	4 16	5.6 -	mA
Gate-emitter leakage current $V_{GE} = 20\text{ V}, V_{CE} = 0\text{ V}$	I_{GES}	-	-	320	nA

AC Characteristics

Transconductance $V_{CE} = 20\text{ V}, I_C = 300\text{ A}$	g_{fs}	124	-	-	S
Input capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	C_{iss}	-	22	-	nF
Output capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	C_{oss}	-	3.3	-	
Reverse transfer capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	C_{rss}	-	1.2	-	

Electrical Characteristics, at $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

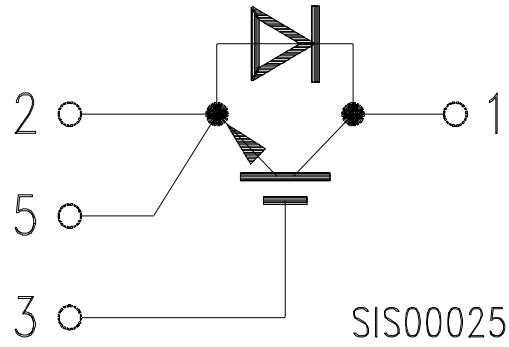
Switching Characteristics, Inductive Load at $T_j = 125\text{ °C}$

Turn-on delay time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 300\text{ A}$ $R_{Gon} = 3.3\ \Omega$	$t_{d(on)}$	-	100	200	ns
Rise time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 300\text{ A}$ $R_{Gon} = 3.3\ \Omega$	t_r	-	110	220	
Turn-off delay time $V_{CC} = 600\text{ V}$, $V_{GE} = -15\text{ V}$, $I_C = 300\text{ A}$ $R_{Goff} = 3.3\ \Omega$	$t_{d(off)}$	-	600	800	
Fall time $V_{CC} = 600\text{ V}$, $V_{GE} = -15\text{ V}$, $I_C = 300\text{ A}$ $R_{Goff} = 3.3\ \Omega$	t_f	-	80	120	

Free-Wheel Diode

Diode forward voltage $I_F = 300\text{ A}$, $V_{GE} = 0\text{ V}$, $T_j = 25\text{ °C}$ $I_F = 300\text{ A}$, $V_{GE} = 0\text{ V}$, $T_j = 125\text{ °C}$	V_F	-	2.3	2.8	V
Reverse recovery time $I_F = 300\text{ A}$, $V_R = -600\text{ V}$, $V_{GE} = 0\text{ V}$ $di_F/dt = -2500\text{ A}/\mu\text{s}$, $T_j = 125\text{ °C}$	t_{rr}	-	0.55	-	
Reverse recovery charge $I_F = 300\text{ A}$, $V_R = -600\text{ V}$, $V_{GE} = 0\text{ V}$ $di_F/dt = -2500\text{ A}/\mu\text{s}$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$	Q_{rr}	-	14	-	μC
		-	40	-	

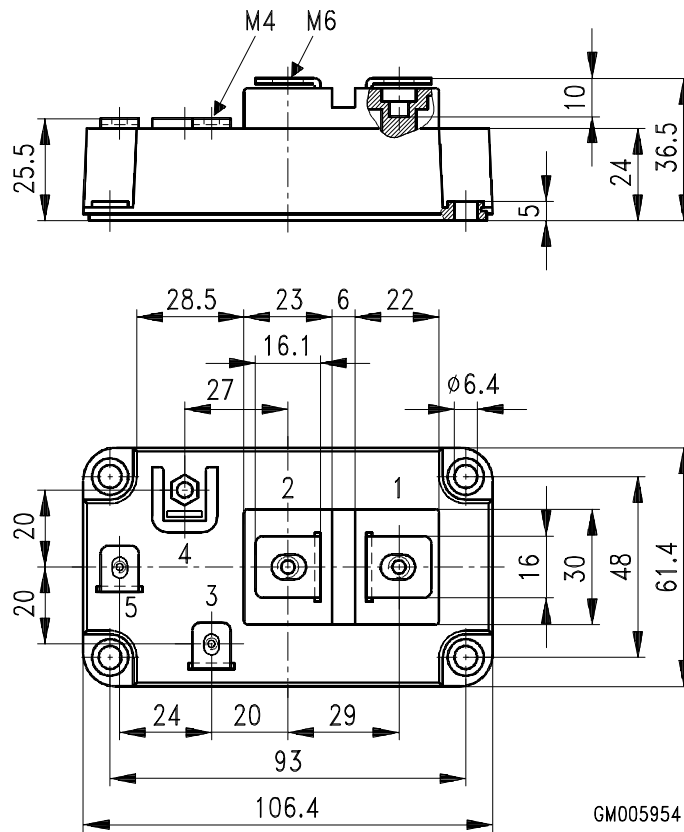
Circuit Diagram



Package Outlines

Dimensions in mm

Weight: 420 g





Anhang C-Serie
Appendix C-series

Gehäuse spezifische Werte
Housing specific values

typ.

Modulinduktivität stray inductance module		L_{SCE}	16	nH
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Gehäusemaße C-Serie
Package outline C-series

